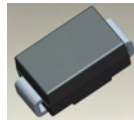


## Features

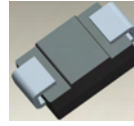
- Low Forward Voltage Drop
- Guard Ring Die Construction for Transient Protection
- Ideally Suited for Automated Assembly
- Low Power Loss, High Efficiency
- **Lead Free Finish, RoHS Compliant (Note 1)**
- **Green Molding Compound (No Halogen and Antimony) (Note 4)**

## Mechanical Data

- Case: SMA
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208
- Polarity: Cathode Band or Cathode Notch
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.064 grams (approximate)



Top View



Bottom View

## Maximum Ratings @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.  
For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	$V_{RRM}$	30	V
Working Peak Reverse Voltage @ $I_R = 1\text{mA}$	$V_{RWM}$		
Blocking Voltage	$V_R$		
RMS Reverse Voltage	$V_{R(RMS)}$	21	V
Average Rectified Output Current @ $T_T = 105^\circ\text{C}$	$I_O$	1.0	A
Peak Repetitive Forward Current (Note 2)	$I_{FRM}$	2.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	$I_{FSM}$	25	A

## Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Terminal	$R_{\theta JT}$	27	$^\circ\text{C/W}$
Operating Temperature Range	$T_J$	-55 to +125	$^\circ\text{C}$
Storage Temperature Range	$T_{STG}$	-55 to +150	$^\circ\text{C}$

## Electrical Characteristics @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage Drop	$V_F$	-	-	0.41	V	$I_F = 1.0\text{A}, T_J = 25^\circ\text{C}$
		-	-	0.35		$I_F = 1.0\text{A}, T_J = 100^\circ\text{C}$
		-	-	0.47		$I_F = 2.0\text{A}, T_J = 25^\circ\text{C}$
		-	-	0.43		$I_F = 2.0\text{A}, T_J = 100^\circ\text{C}$
Leakage Current (Note 3)	$I_R$	-	-	0.4	mA	$V_R = 15\text{V}, T_A = 25^\circ\text{C}$
		-	-	12		$V_R = 15\text{V}, T_A = 100^\circ\text{C}$
		-	-	1.0		$V_R = 30\text{V}, T_A = 25^\circ\text{C}$
		-	-	25		$V_R = 30\text{V}, T_A = 100^\circ\text{C}$
Total Capacitance	$C_T$	-	-	110	pF	$V_R = 4\text{V}, f = 1\text{MHz}$

- Notes:
1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied. Please visit our website at [http://www.diodes.com/quality/lead\\_free.html](http://www.diodes.com/quality/lead_free.html).
  2. At Rated  $V_R$ , Square Wave, 25KHz,  $T_C = 40^\circ\text{C}$ .
  3. Short duration pulse test used to minimize self-heating effect.
  4. Product manufactured with Data Code 0924 (week 24, 2009) and newer are built with Green Molding Compound.

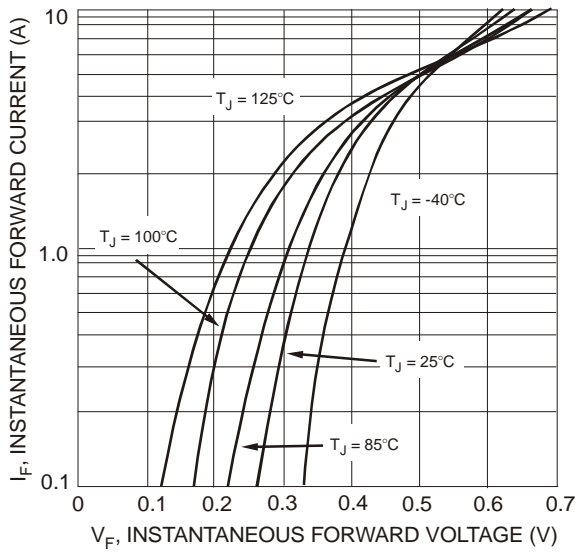


Fig. 1 Typical Forward Characteristics

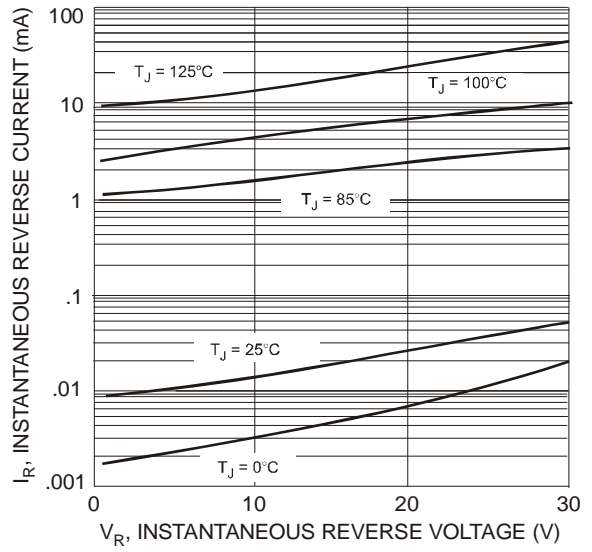


Fig. 2 Typical Reverse Characteristics

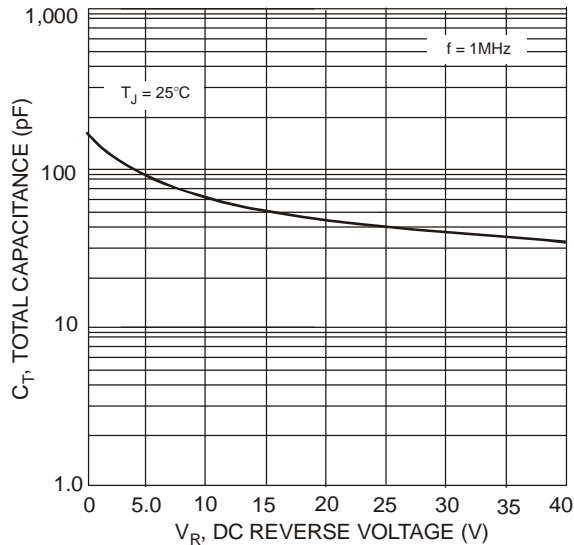


Fig. 3 Total Capacitance vs. Reverse Voltage

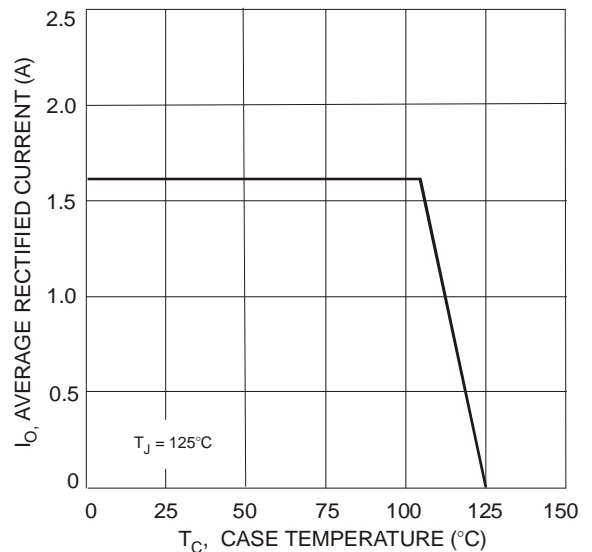


Fig. 4 Forward Current Derating Curve

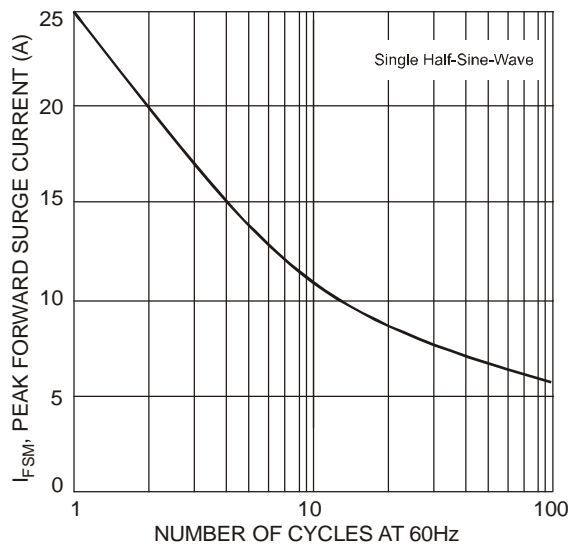


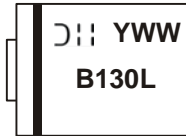
Fig. 5 Max Non-Repetitive Peak Forward Surge Current

**Ordering Information** (Note 5)

Part Number	Case	Packaging
B130L-13-F	SMA	5000/Tape & Reel

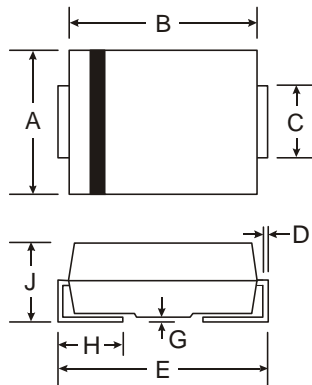
Notes: 5. For packaging details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

**Marking Information**



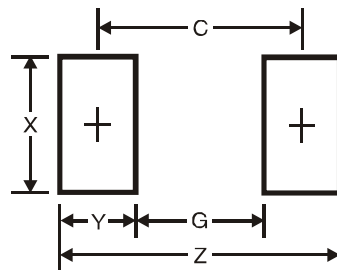
B130L = Product type marking code  
 YWW = Date code marking  
 Y = Last digit of year ex: 6 for 2006  
 WW = Week code 01 to 52

**Package Outline Dimensions**



SMA		
Dim	Min	Max
A	2.29	2.92
B	4.00	4.60
C	1.27	1.63
D	0.15	0.31
E	4.80	5.59
G	0.05	0.20
H	0.76	1.52
J	2.01	2.30
All Dimensions in mm		

**Suggested Pad Layout**



Dimensions	Value (in mm)
Z	6.5
G	1.5
X	1.7
Y	2.5
C	4.0

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